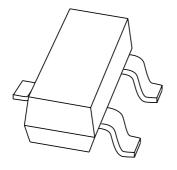
DISCRETE SEMICONDUCTORS

DATA SHEET



PBSS5130T 30 V, 1 A PNP low V_{CEsat} (BISS) transistor

Product specification

2003 Dec 12





30 V, 1 A PNP low V_{CEsat} (BISS) transistor

PBSS5130T

FEATURES

- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability: I_C and I_{CM}
- Higher efficiency leading to less heat generation
- Reduced printed-circuit board requirements
- Cost effective alternative to MOSFETS in specific applications.

APPLICATIONS

- · Power management
 - DC/DC converters
 - Supply line switching
 - Battery charger
 - LCD backlighting.
- · Peripheral drivers
 - Driver in low supply voltage applications (e.g. lamps and LEDs)
 - Inductive load driver (e.g. relays, buzzers and motors).

DESCRIPTION

PNP low V_{CEsat} transistor in a SOT23 plastic package.

MARKING

TYPE NUMBER	MARKING CODE(1)
PBSS5130T	*3E

Note

* = p : made in Hong Kong
 * = t : made in Malaysia

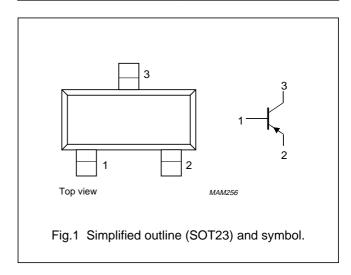
* = W : made in China.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	-30	٧
I _C	collector current (DC)	-1	Α
I _{CRP}	repetitive peak collector current	-1.5	А
R _{CEsat}	equivalent on-resistance	220	mΩ

PINNING

PIN	DESCRIPTION
1	base
2	emitter
3	collector



30 V, 1 A PNP low V_{CEsat} (BISS) transistor

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ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
TIPE NUMBER	NAME	DESCRIPTION	VERSION
PBSS5130T	_	plastic surface mounted package; 3 leads	SOT23

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-30	V
V _{CEO}	collector-emitter voltage	open base	_	-30	V
V _{EBO}	emitter-base voltage	open collector	_	- 5	V
I _C	collector current (DC)		_	-1	Α
I _{CM}	peak collector current		_	-3	Α
I _{BM}	peak base current		_	-300	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C			
		note 1	_	300	mW
		note 2	_	480	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Device mounted on an FR4 printed-circuit board, single-sided copper, tinplated, standard footprint.
- 2. Device mounted on an FR4 printed-circuit board, single sided-copper, tinplated, mounting pad for collector 1 cm².

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to	in free air		
	ambient	note 1	417	K/W
		note 2	260	K/W

Notes

- 1. Device mounted on an FR4 printed-circuit board, single-sided copper, tinplated and standard footprint.
- 2. Device mounted on an FR4 printed-circuit board, single-sided copper, tinplated and mounting pad for collector 1 cm².

30 V, 1 A PNP low V_{CEsat} (BISS) transistor

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = -30 \text{ V}; I_E = 0$	_	_	-100	nA
		$V_{CB} = -30 \text{ V}; I_E = 0; T_j = 150 ^{\circ}\text{C}$	_	_	-50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = -4 \text{ V}; I_C = 0$	_	_	-100	nA
h _{FE}	DC current gain	$V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}$	300	450	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -500 \text{ mA}$	260	350	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -1 \text{ A}$	210	290	_	
V _{CEsat}	collector-emitter saturation voltage	$I_C = -100 \text{ mA}; I_B = -1 \text{ mA}$	_	_	-100	mV
		$I_C = -1 \text{ A}; I_B = -50 \text{ mA}$	_	_	-225	mV
R _{CEsat}	equivalent on-resistance	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}; \text{ note 1}$	_	_	220	mΩ
V_{BEon}	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}$	_	_	-0.75	V
f⊤	transition frequency	$I_C = -100 \text{ mA}; V_{CE} = -10 \text{ V};$ f = 100 MHz	100	200	_	MHz
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	_	_	28	pF

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

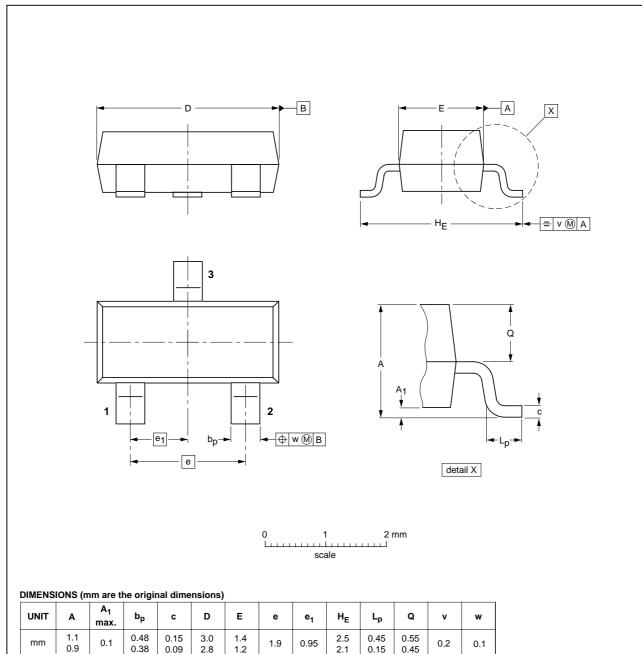
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PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT23



OUTLINE	REFERENCES		EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION 1550E DA	
SOT23		TO-236AB				-97-02-28 99-09-13

30 V, 1 A PNP low V_{CEsat} (BISS) transistor

PBSS5130T

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

Notes

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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